ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INCOMPACTING OCOPYRIGHT 2005. international and Pa	IPC, Bannockt	ourn, Illinois. A	ll rights reserved u ntions.	nder both	This docum level parts, t	ent is a declaration	ion of the s encompasse	ubstances es all lowe	within the manufacture or level materials for w	rer listed i	tem. Note: i nanufacture	if the item is an as r has engineering	sembly with lower responsibility.	
	I.1IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175xFor Dis								als and Mfg Information					
Supplier Information														
Company name* Co			Company unique ID			Unique ID Authority					Response Date*			
onsemi										2024-05	2024-05-12			
Contact Name Title - Cont			- Contact			Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards Product E			duct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - R			le - Representative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards Produc			roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	ter Item Number Mfr Item		Number Mfr Item Name			Effective Date	Version	n Manufacturing Site			Weight*	UOM	Unit Type	
	QEB373	ZR	LED T3-4 ALGAAS ZBEND T&R		٤R	2024-05-12			EVERLGFG		18.7	mg	Each	
Manufacturing Proccess Informa	ation		•											
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base A		Alloy J	-STD-020 MSL	Rating	Peak Pro	ess Body T	Temperatu	re Max Time at Peak	Temperat	ure Num	ber of Reflow Cy	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy	2	2		260		С	30	secon	ids 3			
Comments														
ATTENTION: MSL 2 Rated item requir	es Dry Pack (a	after electrical	test)											
For more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	inition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead bury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe ve independently verified such information. How heir contributions to the part, and those certifica anditions of that agreement, including any warr	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	nditions of that agreement, including any warranty rights and/or remedies provided as part of ation the Supplier provides in this form. In the absence of such written agreement, the							
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.05	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.0195	mg
			Supplier	Silicon (Si)	7440-21-3		0.0305	mg
Die Attach	0.051	mg	Supplier	Silver (Ag)	7440-22-4		0.0441	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0069	mg
Lead Frame	6.38	mg	Supplier	Silver (Ag)	7440-22-4		0.032	mg
			Supplier	Tin (Sn)	7440-31-5		0.032	mg
			Supplier	Copper (Cu)	7440-50-8		6.316	mg
Mold Compound-Black	9.009	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.505	mg
			Supplier	2,4,6-Tris[Bis(Methoxymethyl)Amino]- 1,3,5-Triazine	3089-11-0		4.504	mg
Plating	3.2	mg	Supplier	Tin (Sn)	7440-31-5		3.2	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg